

**2018 International Conference on Smart Engineering Materials (ICSEM 2018)**  
**Bucharest, Romania**  
**March 07-09, 2018**



## Conference Introduction

2018 International Conference on Smart Engineering Materials (ICSEM 2018: <http://www.icsem.org/>) will be held in Bucharest, Romania during March 07-09, 2018. It provides an opportunity for the delegates to meet, interact and exchange new ideas in the various areas of smart engineering materials. ICSEM 2018 aims in proclaim knowledge and share new ideas amongst the professionals, industrialists and students from research areas of smart engineering materials to share their research experiences and indulge in interactive discussions and special sessions at the event.

## Good News

### 1. Publication

**Option One: IOP Conference Series: Materials Science and Engineering** (ISSN: 1757-899X), which is indexed by **EI Compendex**, **Scopus**, Thomson Reuters (WoS), Inspec, et al.



**Option Two: International Journal of Materials Science and Engineering** (IJMSE, ISSN: 2315-4527).



### 2. Famous professors as Speakers

**Prof. Pankaj Vadgama**, Queen Mary University of London, UK;

**Prof. Ian Butler**, McGill University, Canada;

**Prof. Maria Tomoaia-Cotisel**, Babes-Bolyai University of Cluj-Napoca, Romania.

### 3. Academic Visit

There will be a one-day academic visit in Bucharest on March 09, 2018.

## Important Dates

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Paper Submission	before October 25, 2017
Notification of Acceptance	on November 15, 2017
Registration	before December 05, 2017
Conference Dates	March 07-08, 2018
Academic Visit	March 09, 2018

## Call for Papers

Topics of interest for submission include, but are not limited to: Carbonaceous Materials, Wide Band Gap Materials, Nanomaterials and their Arrangements, Functional Materials (bio-fillic, bio-folic, optic), Two Dimensional Materials, Plasma Assisted Processes, New Structures and New Applications, Graphene, Non Ferrous Metal Material, Iron and Steel, High Strength Alloys, Materials Processing and Handling, Composites, Micro/Nano Materials, Optical, Electronic, Magnetic Materials, Metallurgical Fundamentals and Techniques, Carbon Based Materials, Building Materials, New Energy Materials, Environmental Friendly Materials, Earthquake Materials and Design, Biomaterials, Smart and Intelligent Materials, Intelligent Materials Systems, Polymeric Materials, Thin Films, Function Test and Evaluation Technology for Material Analysis, Processing Technology for Functional Materials. (For more information, please visit <http://www.icsem.org/cfp.html>)

## Submission Methods

1. Easy Chair System:  
<http://www.easychair.org/conferences/?conf=icsem2018>
2. Conference Email Address: [icsem@cbees.net](mailto:icsem@cbees.net)

## Contact us

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